



## Material Content Data Sheet



<b>Sales Product Name</b>	TLE7718G			<b>Issued</b>	27. September 2017			
<b>MA#</b>	MA001458040							
<b>Package</b>	PG-DSO-52-6			<b>Weight*</b>	871.98 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	27.549	3.16	3.16	31593	31593
leadframe	inorganic material	phosphorus	7723-14-0	0.073	0.01		84	
	non noble metal	zinc	7440-66-6	0.293	0.03		336	
	non noble metal	iron	7439-89-6	5.854	0.67		6714	
wire	non noble metal	copper	7440-50-8	237.701	27.26	27.97	272599	279733
	noble metal	gold	7440-57-5	3.083	0.35	0.35	3535	3535
	encapsulation	organic material	carbon black	1333-86-4	1.163	0.13		1333
encapsulation	plastics	epoxy resin	-	53.484	6.13		61337	
	inorganic material	silicondioxide	60676-86-0	526.706	60.41	66.67	604034	666704
leadfinish	non noble metal	tin	7440-31-5	7.602	0.87	0.87	8718	8718
plating	noble metal	silver	7440-22-4	0.935	0.11	0.11	1072	1072
glue	plastics	epoxy resin	-	1.885	0.22		2161	
	noble metal	silver	7440-22-4	5.654	0.65	0.87	6484	8645
*deviation	< 10%			Sum in total:		100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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